

October 6, 2003

To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Fr: George O. Saile     Reg. No. 19,572  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

Subject:

**Divisional Patent Application of**  
Serial No.: 09/859,353 5/18/01

YEUNG-WAY TEH, VICTOR SENG KEONG LIM, TING  
CHEONG ANG

NOVEL COPPER METAL STRUCTURE FOR THE  
REDUCTION OF INTRA-METAL CAPACITANCE

**PRELIMINARY AMENDMENT**

Dear Sir:

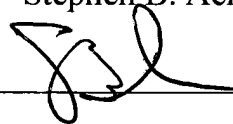
This is a preliminary amendment for the above referenced Divisional Patent  
Application. Please amend the above identified application for patent as follows:

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States  
Postal Service as first class mail in an envelope addressed to: Commissioner of Patents  
and Trademarks, Washington, D.C. 20231, on October 6, 2003.

Stephen B. Ackerman, Reg. No. 37,761

Signature/Date

 10/6/03